

# BIOFY® Sensor

## Version 1.0

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### SFH 7072



#### Features:

- Multi chip package featuring two green emitters, one red emitter, one infrared emitter and two detectors
- Package size: (WxDxH) 7.5 mm x 3.9 mm x 0.9 mm
- Light Barriers to block optical crosstalk
- optimized for strong PPG signal

#### Applications

- Heart rate monitoring
- Pulse oximetry

#### for:

- Wearable devices (e.g. smart watches, fitness trackers, ...)
- Mobile devices

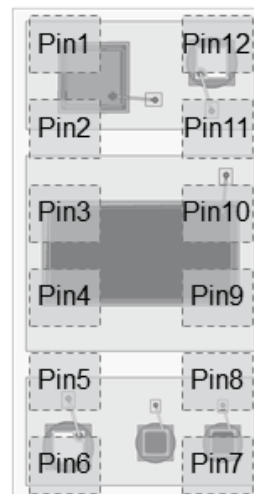
#### Ordering Information

Type	Ordering Code
SFH7072	Q65112A1516

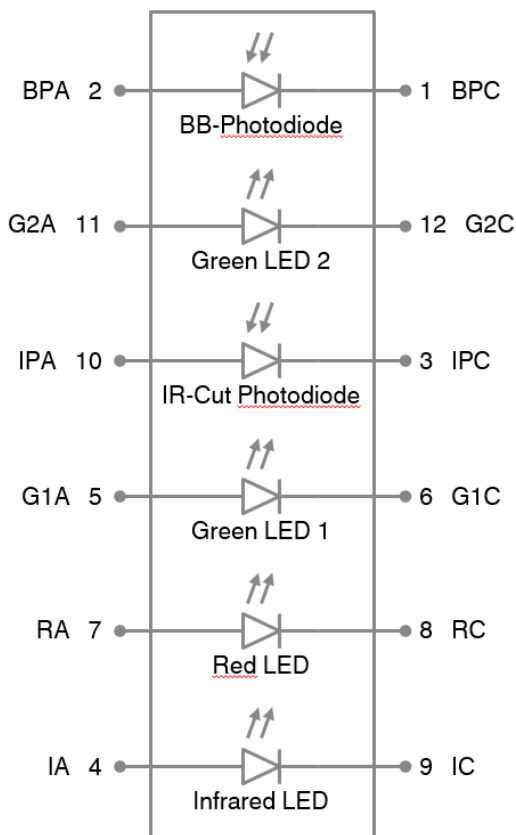
## Pin configuration

Pin	Name	Function
1	BPC	Broadband photodiode cathode
2	BPA	Broadband photodiode anode
3	IPC	IR-Cut photodiode cathode
4	IA	Infrared LED anode
5	G1A	Green LED 1 anode
6	G1C	Green LED 1 cathode
7	RA	Red LED anode
8	RC	Red LED cathode
9	IC	Infrared LED cathode
10	IPA	IR-Cut photodiode anode
11	G2A	Green LED 2 anode
12	G2C	Green LED 2 cathode

## Top View



## Block diagram



**Maximum Ratings** ( $T_A = 25\text{ °C}$ )

Parameter	Symbol	Values	Unit
<b>General</b>			
Operating temperature range	$T_{op}$	-40 ... 85	°C
Storage temperature range	$T_{stg}$	-40 ... 85	°C
ESD withstand voltage (acc. to ANSI/ ESDA/ JEDEC JS-001 - HBM)	$V_{ESD}$	2	kV
<b>Infrared Emitter</b>			
Reverse Voltage	$V_R$	5	V
Forward current	$I_{F(DC)}$	60	mA
Surge current ( $t_p = 100\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	1	A
<b>Red Emitter</b>			
Reverse voltage	$V_R$	12	V
Forward current	$I_{F(DC)}$	40	mA
Surge current ( $t_p = 100\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	600	mA
<b>Green Emitters</b>			
Reverse voltage	$V_R$	5	V
Forward current	$I_{F(DC)}$	25	mA
Surge current ( $t_p = 10\ \mu\text{s}$ , $D = 0$ )	$I_{FSM}$	300	mA
<b>Detectors</b>			
Reverse voltage	$V_R$	16	V

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Infrared Emitter</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\lambda_{\text{peak}}$	950	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	940 ( $\pm 10$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Delta\lambda$	42	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	°
Rise and fall time of $I_e$ (10% and 90% of $I_{e\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r, t_f$	16	ns
Forward voltage ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ. (max.))	$V_F$	1.3 ( $\leq 1.8$ )	V
Reverse current ( $V_R = 5\text{ V}$ )		$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	3.9	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	11	mW
Temperature coefficient of $I_e$ or $\Phi_e$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\text{TC}_I$	-0.3	% / K
Temperature coefficient of $V_F$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\text{TC}_V$	-0.8	mV / K
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\text{TC}_{\lambda_{\text{centroid}}}$	0.25	nm / K

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Red Emitter</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ )	(typ.)	$\lambda_{\text{peak}}$	660	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	655 ( $\pm 3$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ )	(typ.)	$\Delta\lambda$	17	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	$^\circ$
Rise and fall time of $I_e$ (10% and 90% of $I_{e\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r, t_f$	17	ns
Forward voltage ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$V_F$	2.1 ( $\leq 2.8$ )	V
Reverse current ( $V_R = 12\text{V}$ )		$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	4.8	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	14	mW
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $-10\text{ }^\circ\text{C} \leq T \leq 100\text{ }^\circ\text{C}$ )	(typ.)	$\text{TC}_{\lambda_{\text{centroid}}}$	0.13	nm / K

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Green Emitter (single emitter)</b>				
Wavelength of peak emission ( $I_F = 20\text{ mA}$ )	(typ.)	$\lambda_{\text{peak}}$	526	nm
Centroid Wavelength ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$\lambda_{\text{centroid}}$	530 ( $\pm 10$ )	nm
Spectral bandwidth at 50% of $I_{\text{max}}$ ( $I_F = 20\text{ mA}$ )	(typ.)	$\Delta\lambda$	32	nm
Half angle	(typ.)	$\varphi$	$\pm 60$	°
Rise and fall time of $I_e$ (10% and 90% of $I_{e\text{max}}$ ) ( $I_F = 100\text{ mA}$ , $t_p = 16\text{ }\mu\text{s}$ , $R_L = 50\text{ }\Omega$ )	(typ.)	$t_r, t_f$	56	ns
Forward voltage ( $I_F = 20\text{ mA}$ )	(typ. (max.))	$V_F$	3.0 ( $\leq 3.4$ )	V
Reverse current ( $V_R = 5\text{ V}$ )		$I_R$	not designed for reverse operation	$\mu\text{A}$
Radiant intensity ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$I_e$	3.8	mW / sr
Total radiant flux ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$\Phi_e$	11	mW
Temperature coefficient of $I_e$ or $\Phi_e$ ( $I_F = 20\text{ mA}$ , $t_p = 20\text{ ms}$ )	(typ.)	$TC_I$	-0.35	% / K
Temperature coefficient of $\lambda_{\text{centroid}}$ ( $I_F = 20\text{ mA}$ , $-10\text{ °C} \leq T \leq 100\text{ °C}$ )	(typ.)	$TC_{\lambda_{\text{centroid}}}$	0.03	nm / K
Temperature coefficient of $V_F$ ( $I_F = 20\text{ mA}$ , $-10\text{ °C} \leq T \leq 100\text{ °C}$ )	(typ.)	$TC_V$	-3.6	mV / K

Characteristics ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>IR-Cut Detector</b>				
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,530}$	0.985	$\mu\text{A}$
Wavelength of max. sensitivity	(typ.)	$\lambda_{S\text{ max}}$	635	nm
Spectral range of sensitivity	(typ.)	$\lambda_{10\%}$	402 ... 694	nm
Radiation sensitive area	(typ.)	A	3.46	$\text{mm}^2$
Dimensions of radiant sensitive area	(typ.)	L x W	1.29 x 2.69	mm x mm
Half angle	(typ.)	$\varphi$	$\pm 57$	$^\circ$
Dark current ( $V_R = 5\text{ V}$ , $E_e = 0\text{ mW/cm}^2$ )	(typ. (max.))	$I_R$	0.4 ( $\leq 2$ )	nA
Spectral sensitivity of the chip ( $\lambda = 530\text{ nm}$ )	(typ.)	$S_{\lambda 530}$	0.31	A / W
Spectral sensitivity of the chip ( $\lambda > 690\text{ nm}$ )	(typ.)	$S_{IR}$	0.02	A / W
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$V_{O,530}$	390	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$I_{SC,530}$	0.984	$\mu\text{A}$
Rise and fall time ( $V_R = 5\text{ V}$ , $R_L = 50\ \Omega$ , $\lambda = 530\text{ nm}$ )	(typ.)	$t_r, t_f$	40	ns
Forward voltage ( $I_F = 10\text{ mA}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$V_F$	0.84	V
Capacitance ( $V_R = 5\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$C_0$	55	pF

**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
<b>Broadband Detector</b>				
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,530}$	0.26	$\mu\text{A}$
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,655}$	0.46	$\mu\text{A}$
Photocurrent ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ , $V_R = 5\text{ V}$ )	(typ.)	$I_{P,940}$	0.79	$\mu\text{A}$
Wavelength of max. sensitivity	(typ.)	$\lambda_{S\text{ max}}$	960	nm
Spectral range of sensitivity	(typ.)	$\lambda_{10\%}$	410 ... 1100	nm
Radiation sensitive area	(typ.)	A	0.79	$\text{mm}^2$
Dimensions of radiant sensitive area	(typ.)	L x W	0.89 x 0.89	mm x mm
Half angle	(typ.)	$\varphi$	$\pm 60$	$^\circ$
Dark current ( $V_R = 5\text{ V}$ , $E_e = 0\text{ mW/cm}^2$ )	(typ. (max.))	$I_R$	0.05 ( $\leq 10$ )	nA
Spectral sensitivity of the chip ( $\lambda = 530\text{ nm}$ )	(typ.)	$S_{\lambda 530}$	0.31	A / W
Spectral sensitivity of the chip ( $\lambda = 655\text{ nm}$ )	(typ.)	$S_{\lambda 655}$	0.56	A / W
Spectral sensitivity of the chip ( $\lambda = 940\text{ nm}$ )	(typ.)	$S_{\lambda 940}$	0.84	A / W
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$V_{O,530}$	211	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 530\text{ nm}$ )	(typ.)	$I_{SC,530}$	0.24	$\mu\text{A}$
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ )	(typ.)	$V_{O,655}$	249	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 655\text{ nm}$ )	(typ.)	$I_{SC,655}$	0.43	$\mu\text{A}$
Open-circuit voltage ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ )	(typ.)	$V_{O,940}$	266	mV
Short-circuit current ( $E_e = 0.1\text{ mW/cm}^2$ , $\lambda = 940\text{ nm}$ )	(typ.)	$I_{SC,940}$	0.79	$\mu\text{A}$

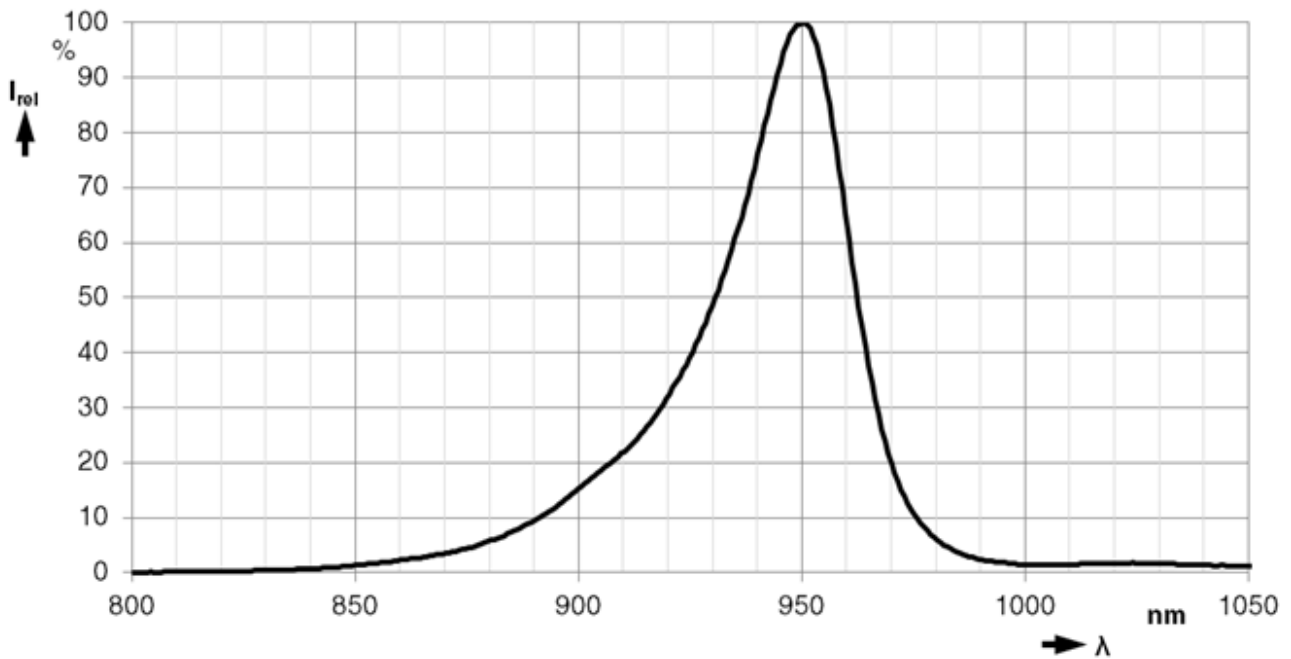


**Characteristics** ( $T_A = 25\text{ °C}$ )

Parameter		Symbol	Value	Unit
Rise and fall time ( $V_R = 5\text{ V}$ , $R_L = 50\ \Omega$ , $\lambda = 940\text{ nm}$ )	(typ.)	$t_r, t_f$	0.75	$\mu\text{s}$
Forward voltage ( $I_F = 100\text{ mA}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$V_F$	1.16	V
Capacitance ( $V_R = 5\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0\text{ mW/cm}^2$ )	(typ.)	$C_0$	4.2	pF

**Diagrams for infrared emitter****Relative spectral emission** <sup>1)</sup>

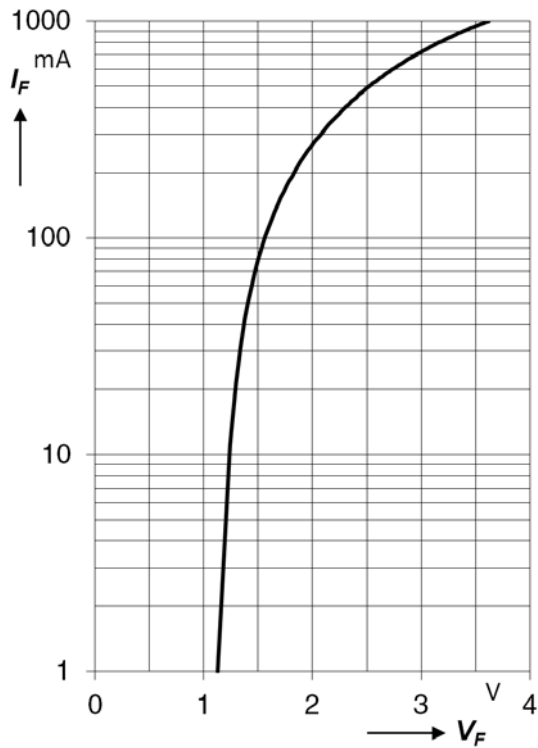
$$I_{\text{rel}} = f(\lambda), T_A = 25\text{ °C}, I_F = 20\text{ mA}$$



**Diagrams for infrared emitter**

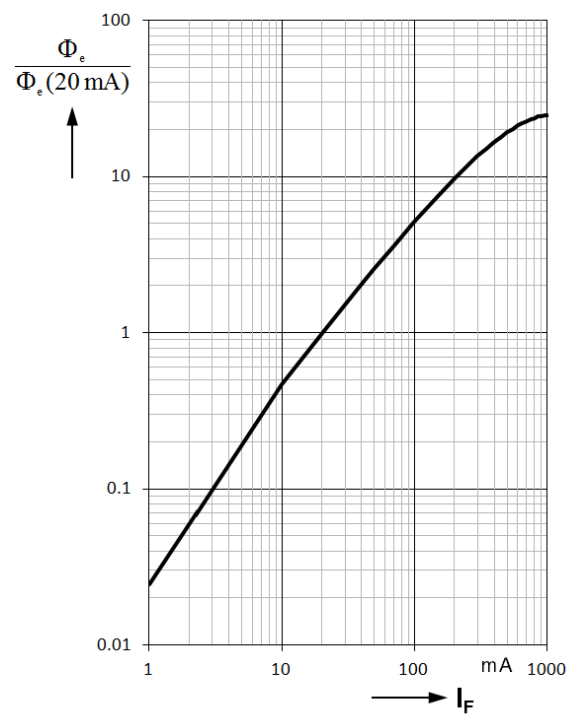
**Forward current <sup>1)</sup>**

$I_F = f(V_F)$ , single pulse,  $t_p = 100 \mu s$ ,  $T_A = 25^\circ C$



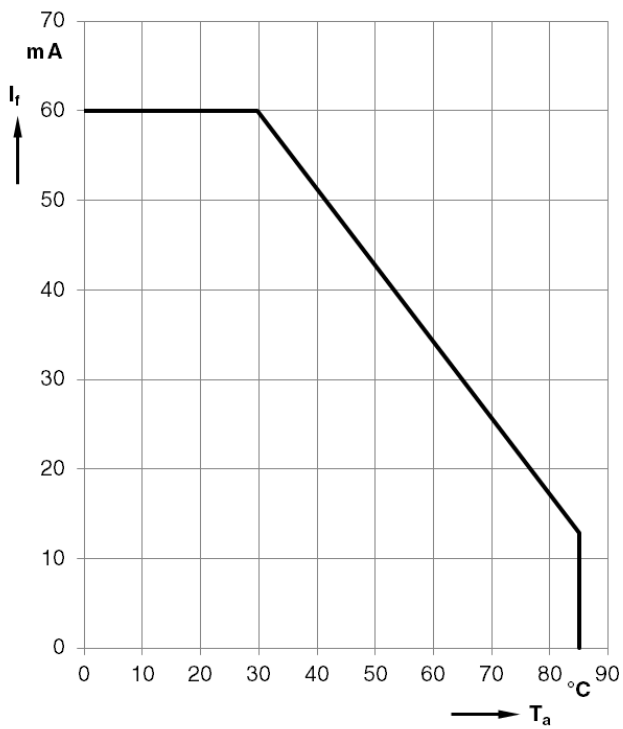
**Relative radiant flux <sup>1)</sup>**

$\Phi_e / \Phi_e(20 \text{ mA}) = f(I_F)$ , single pulse,  $t_p = 25 \mu s$ ,  $T_A = 25^\circ C$



**Max. permissible forward current <sup>1)</sup>**

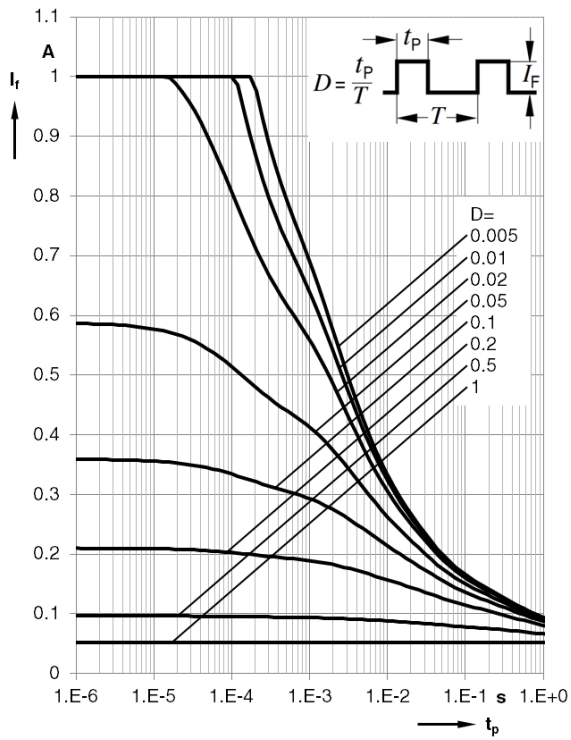
$I_{F,max} = f(T_A)$ ,  $R_{thJA} = 800 \text{ K/W}$



Diagrams for infrared emitter

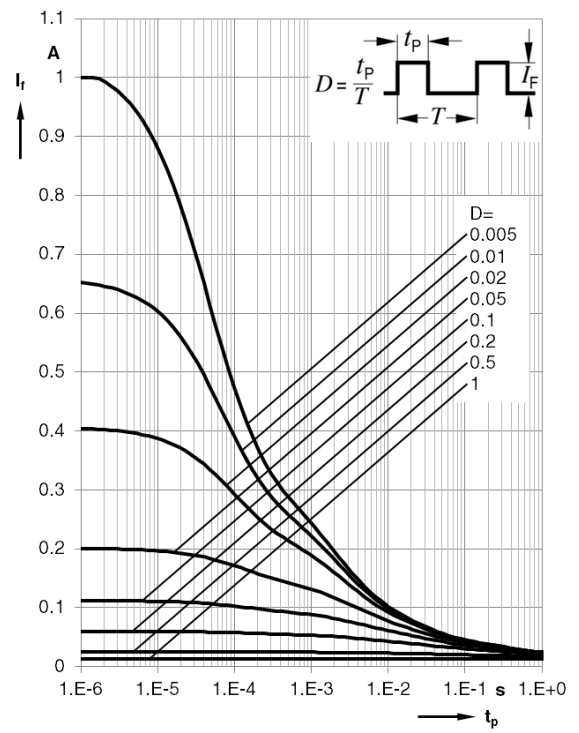
Permissible pulse handling capability <sup>1)</sup>

$I_F = f(t_p)$ ,  $T_A = 40^\circ\text{C}$ , duty cycle  $D = \text{parameter}$



Permissible pulse handling capability <sup>1)</sup>

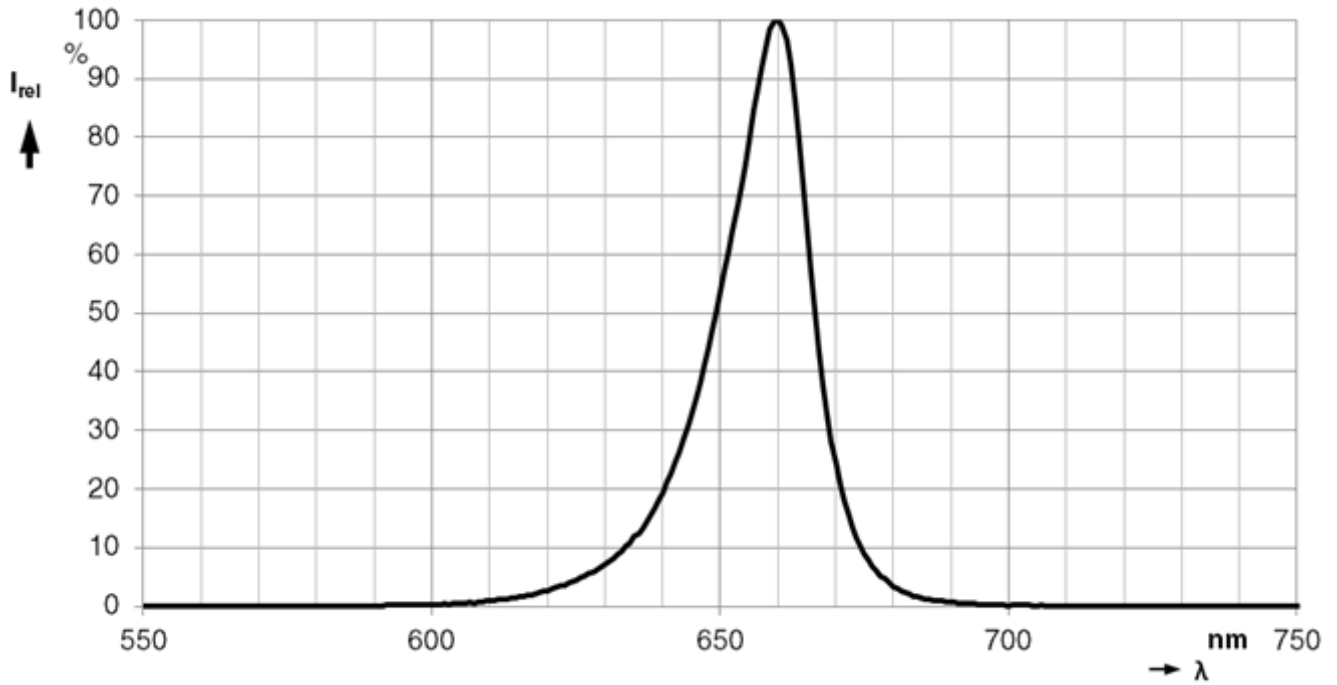
$I_F = f(t_p)$ ,  $T_A = 85^\circ\text{C}$ , duty cycle  $D = \text{parameter}$



Diagrams for red emitter

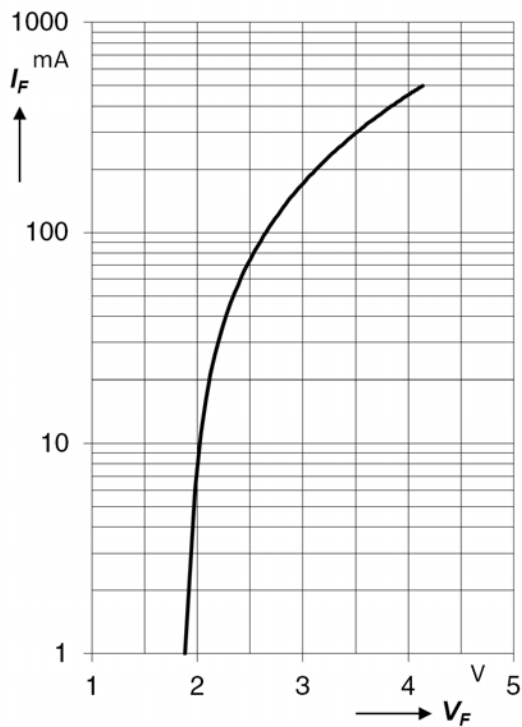
Relative spectral emission <sup>1)</sup>

$I_{rel} = f(\lambda), T_A = 25\text{ }^\circ\text{C}, I_F = 20\text{ mA}$



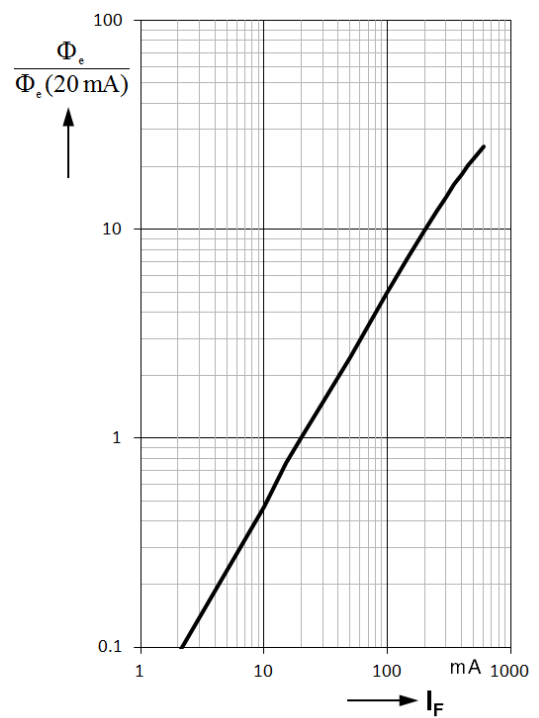
Forward current <sup>1)</sup>

$I_F = f(V_F), T_A = 25\text{ }^\circ\text{C}$



Relative radiant flux <sup>1)</sup>

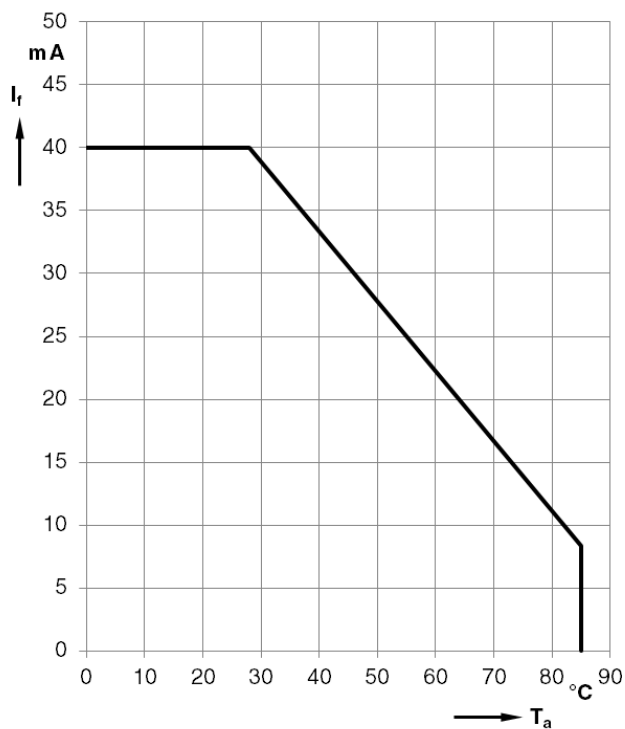
$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F), \text{ single pulse, } t_p = 25\mu\text{s}, T_A = 25\text{ }^\circ\text{C}$



Diagrams for red emitter

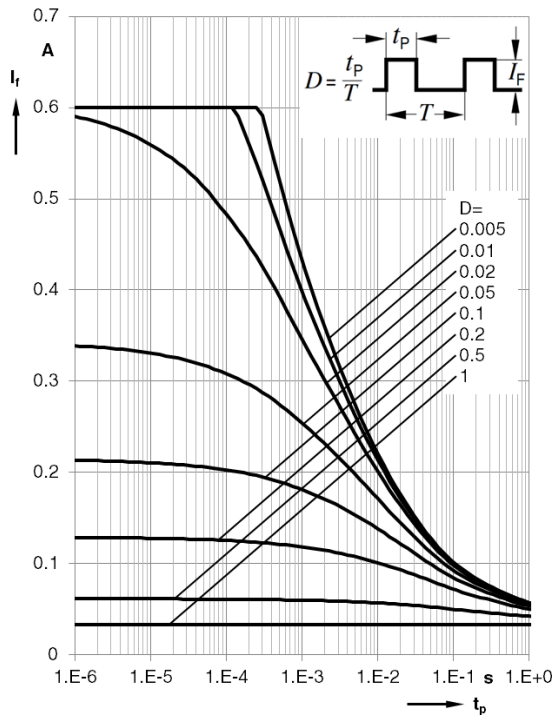
Max. permissible forward current <sup>1)</sup>

$I_{F,max} = f(T_A), R_{thJA} = 800 \text{ K/W}$



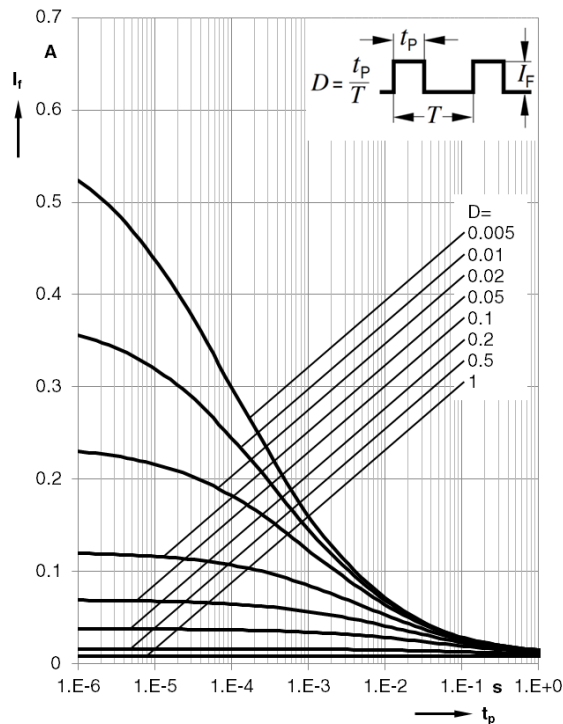
Permissible pulse handling capability <sup>1)</sup>

$I_F = f(t_p), T_A = 40^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$



Permissible pulse handling capability <sup>1)</sup>

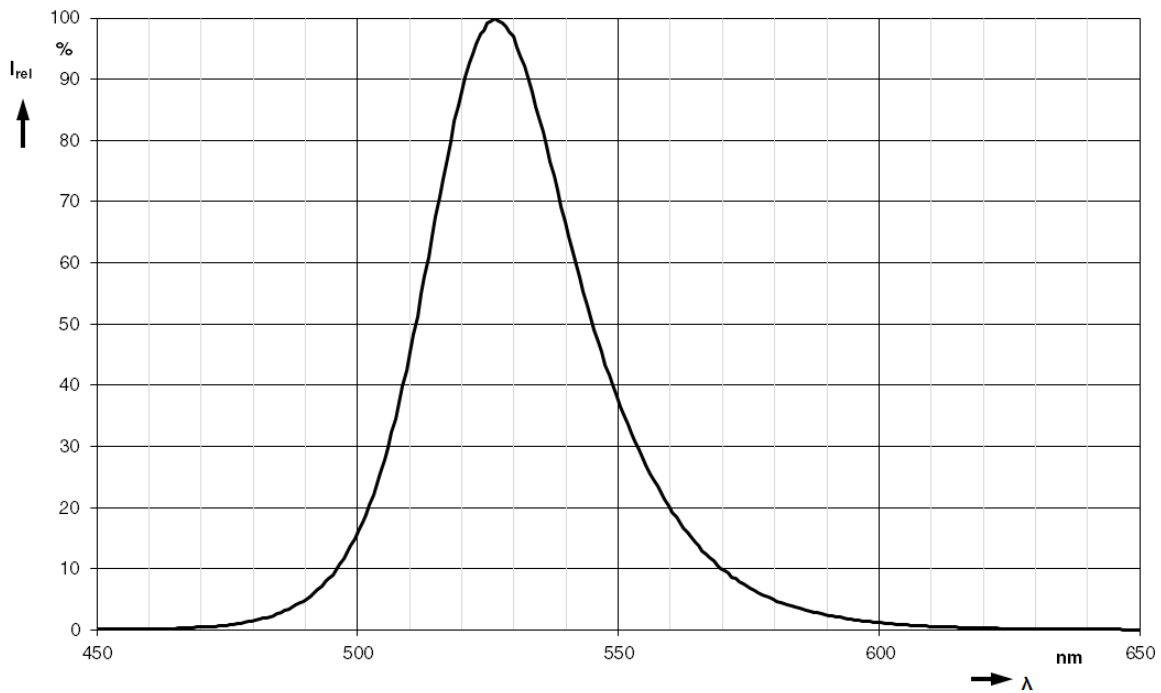
$I_F = f(t_p), T_A = 85^\circ\text{C}, \text{ duty cycle } D = \text{parameter}$



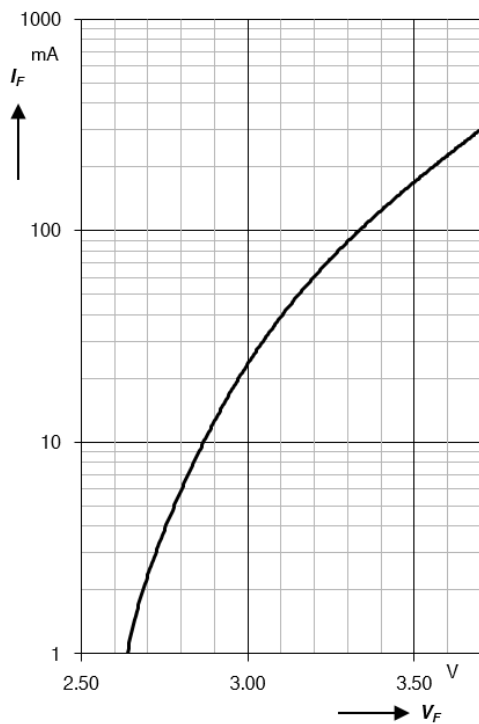
## Diagrams for green emitters

Relative spectral emission <sup>1)</sup>

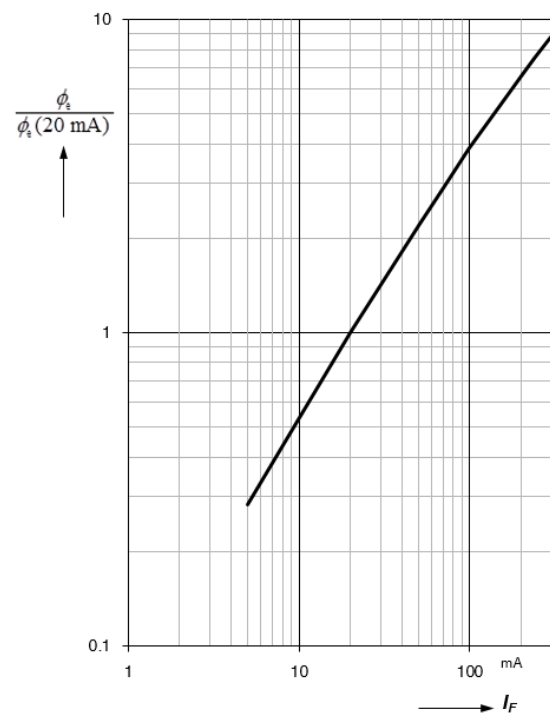
$$I_{\text{rel}} = f(\lambda), T_A = 25^\circ\text{C}, I_F = 20\text{ mA}$$

Forward current <sup>1)</sup>

$$I_F = f(V_F), T_A = 25^\circ\text{C}$$

Relative radiant flux <sup>1)</sup>

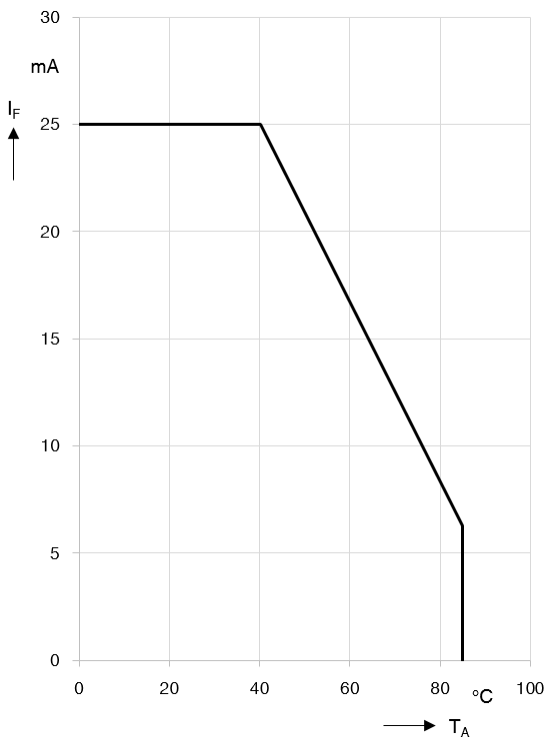
$$\Phi_e / \Phi_e(20\text{ mA}) = f(I_F), \text{ single pulse, } t_p = 25\mu\text{s}, T_A = 25^\circ\text{C}$$



Diagrams for green emitters

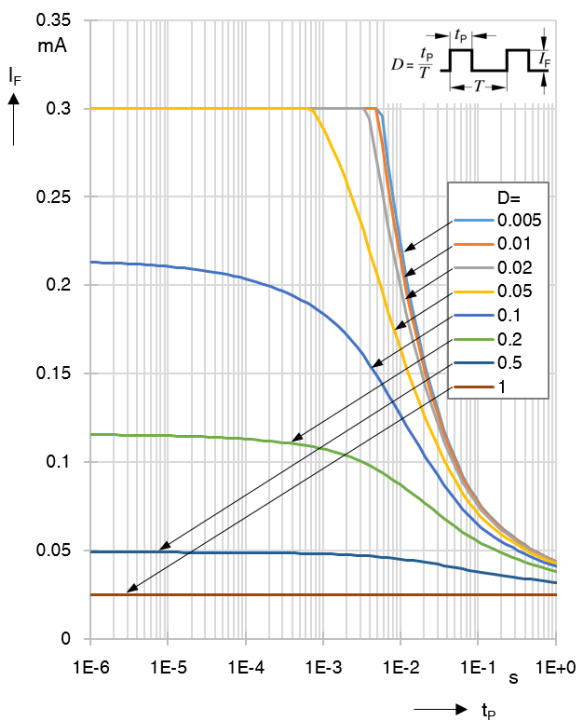
Max. permissible forward current <sup>1)</sup>

$I_{F,max} = f(T_A), R_{thJA} = 800 \text{ K/W}$



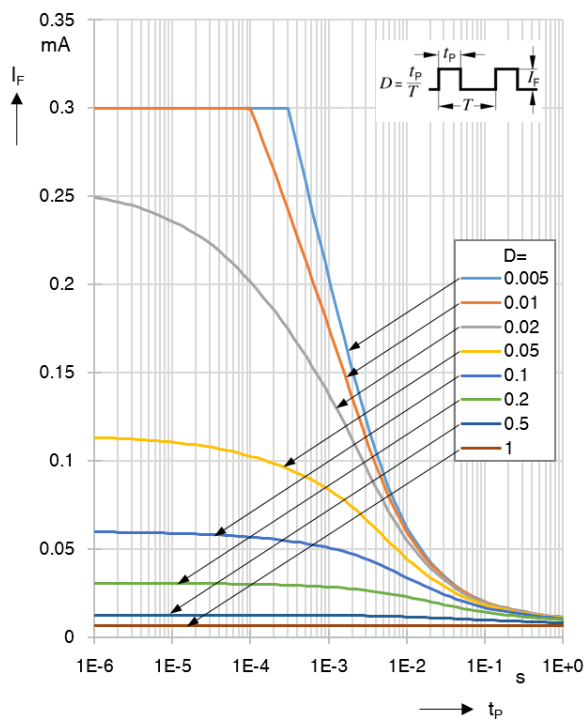
Permissible pulse handling capability <sup>1)</sup>

$I_F = f(t_p), T_A = 40^\circ\text{C}, \text{ duty cycle } D$



Permissible pulse handling capability <sup>1)</sup>

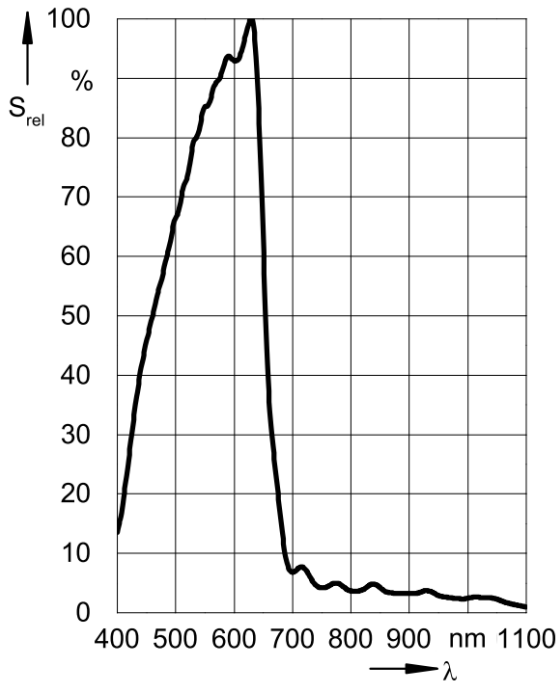
$I_F = f(t_p), T_A = 85^\circ\text{C}, \text{ duty cycle } D$



**Diagrams for IR-Cut detector**

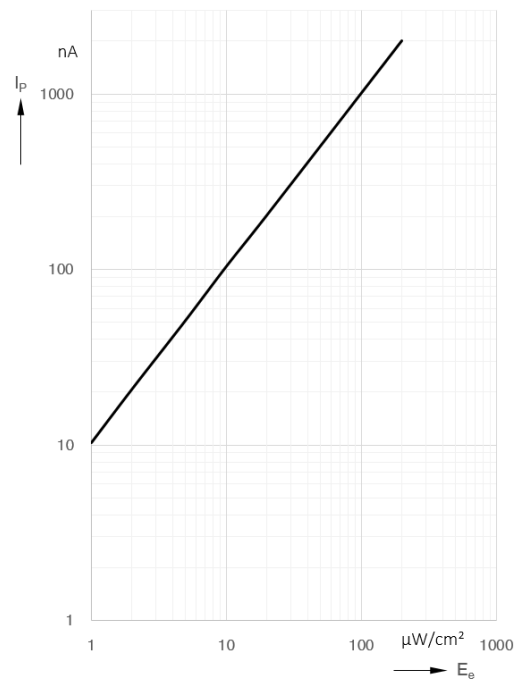
**Relative spectral sensitivity <sup>1)</sup>**

$S_{rel} = f(\lambda), T_A = 25\text{ °C}$



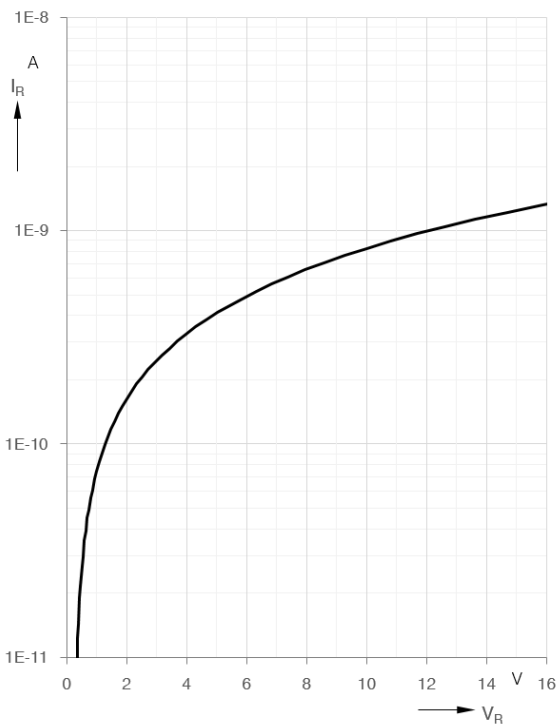
**Photocurrent <sup>1)</sup>**

$I_P(V_R = 5\text{ V}), \lambda = 530\text{ nm}, T_A = 25\text{ °C}$



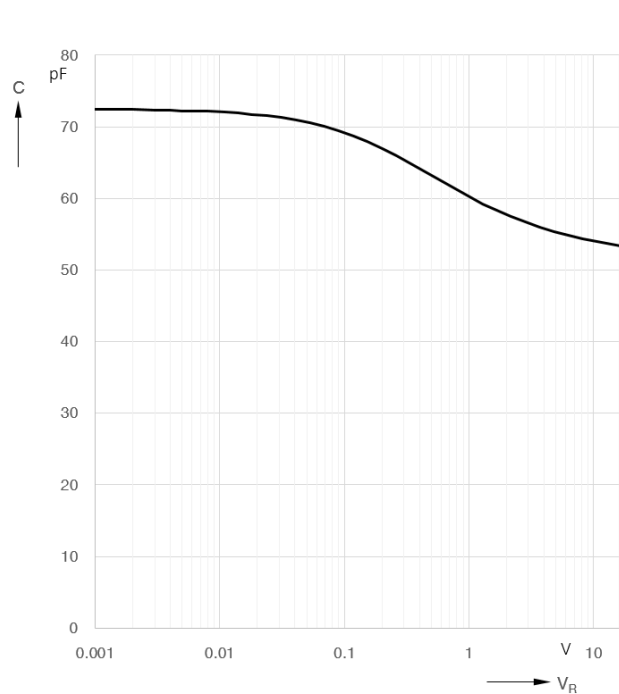
**Dark current <sup>1)</sup>**

$I_R = f(V_R), E = 0\text{ mW/cm}^2, T_A = 25\text{ °C}$



**Capacitance <sup>1)</sup>**

$C = f(V_R), f = 1\text{ MHz}, E = 0\text{ mW/cm}^2, T_A = 25\text{ °C}$

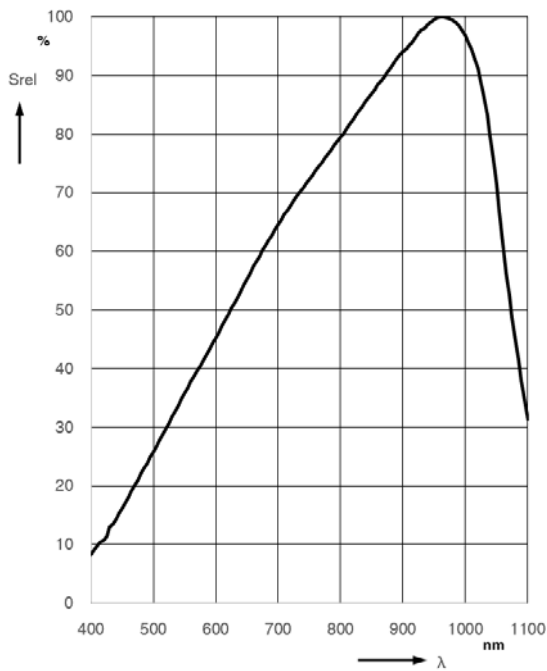




Diagrams for broadband detector

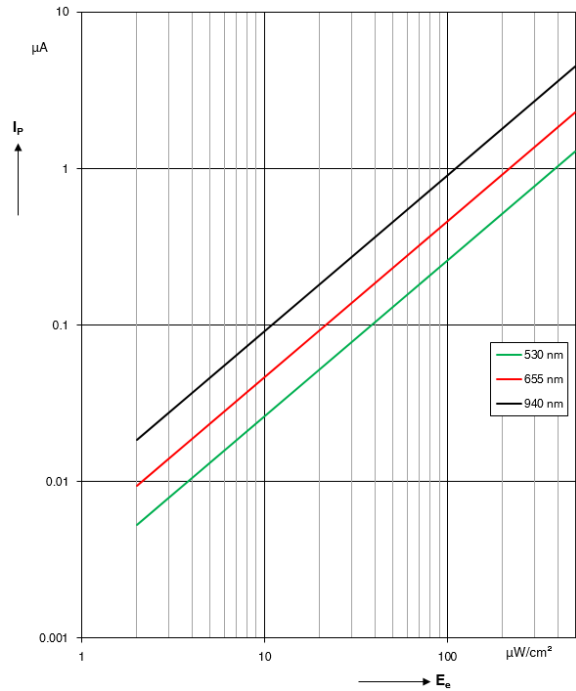
Relative spectral sensitivity <sup>1)</sup>

$S_{rel} = f(\lambda), T_A = 25\text{ °C}$



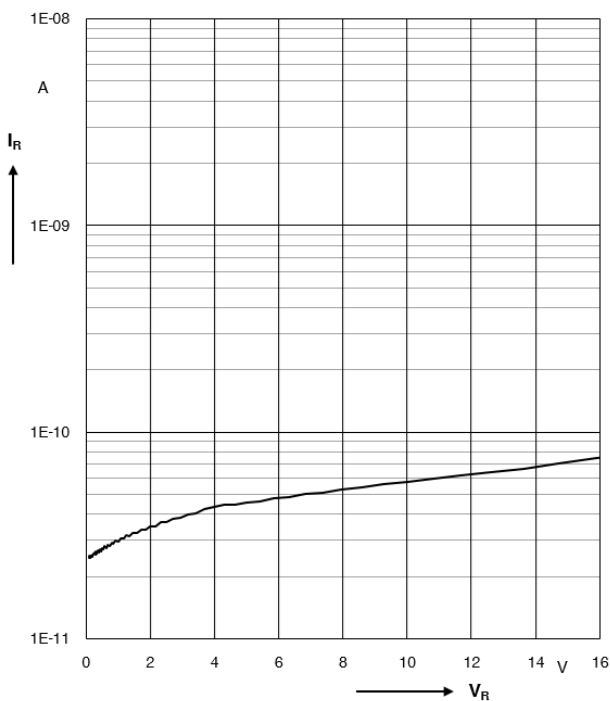
Photocurrent <sup>1)</sup>

$I_P(V_R = 5\text{ V}), \lambda = 530, 655, 940\text{ nm}, T_A = 25\text{ °C}$



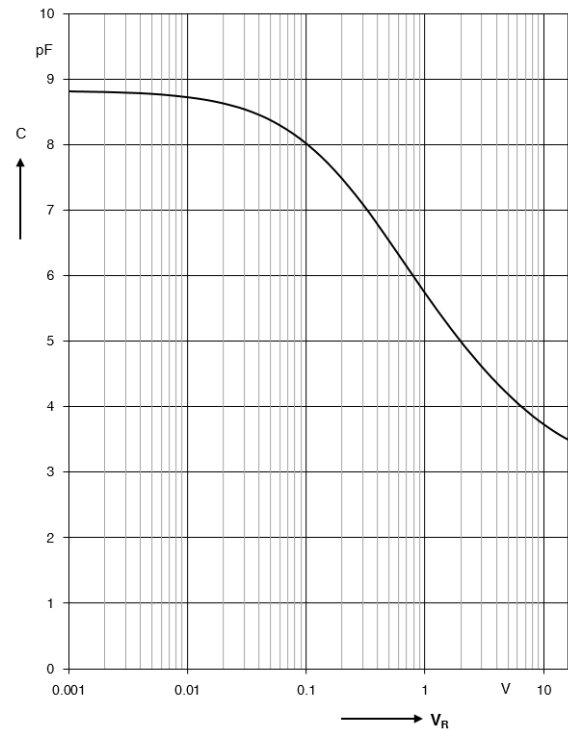
Dark current <sup>1)</sup>

$I_R = f(V_R), E = 0\text{ mW/cm}^2, T_A = 25\text{ °C}$



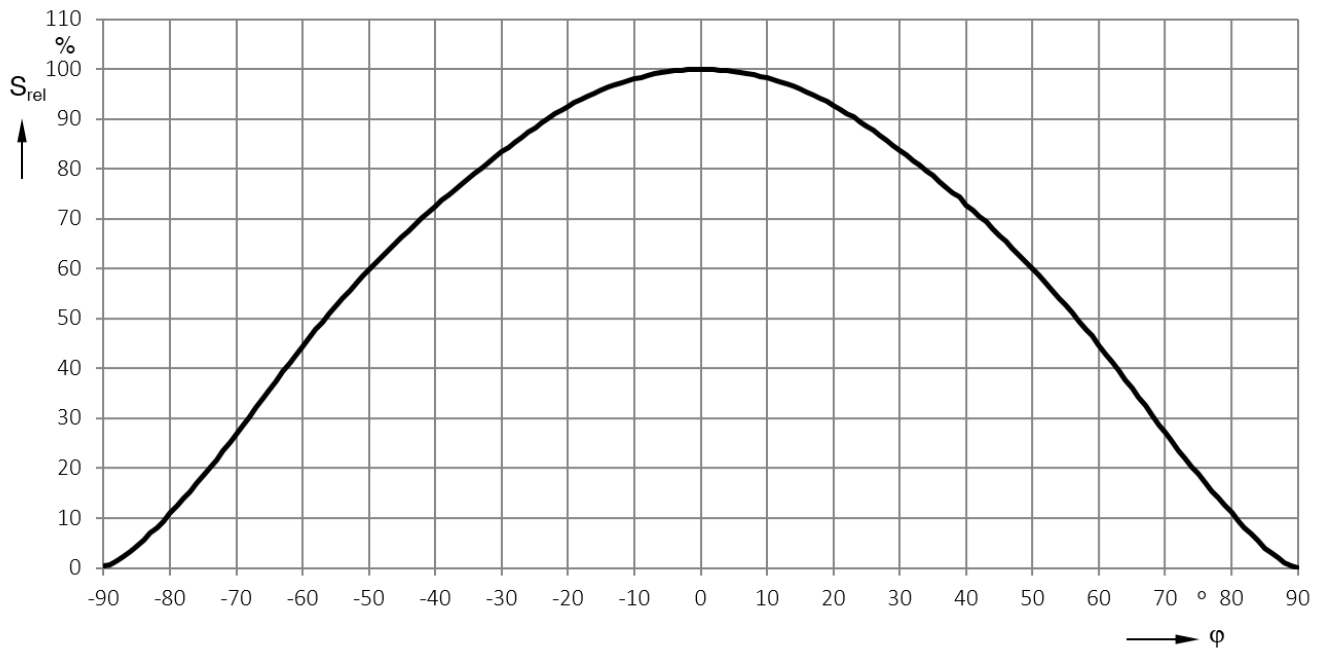
Capacitance <sup>1)</sup>

$C = f(V_R), f = 1\text{ MHz}, E = 0\text{ mW/cm}^2, T_A = 25\text{ °C}$

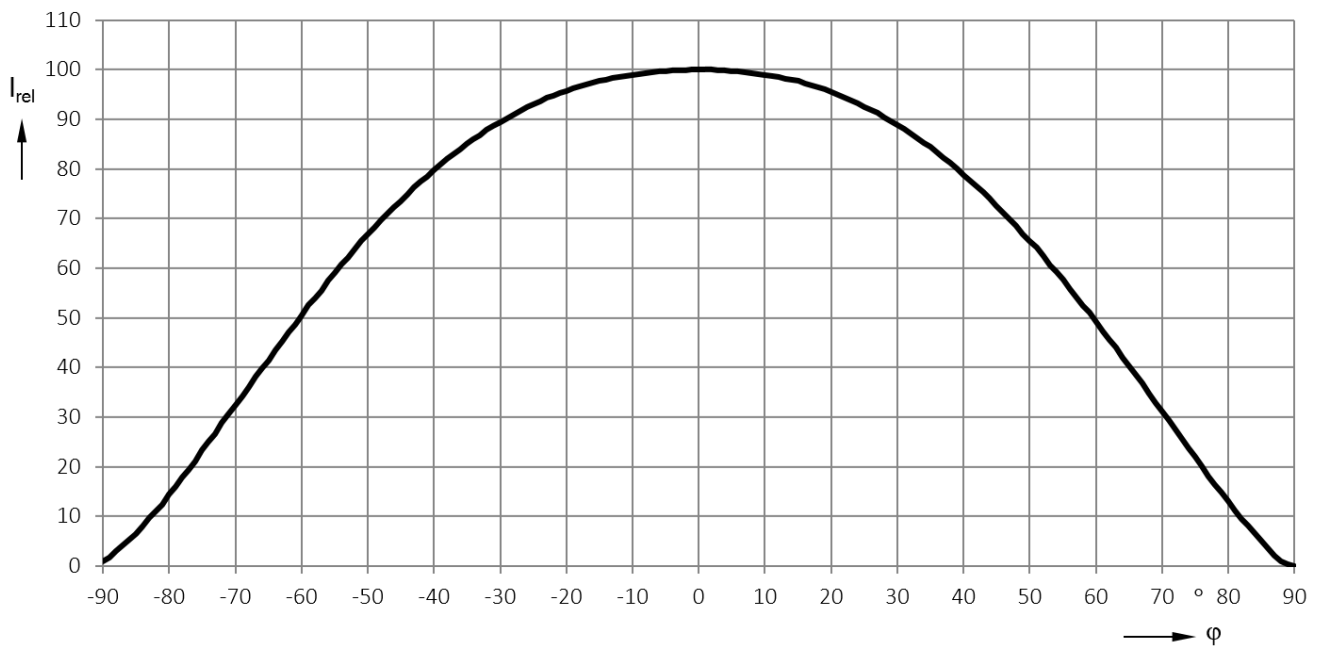


**Directional characteristics of detectors** <sup>1)</sup>

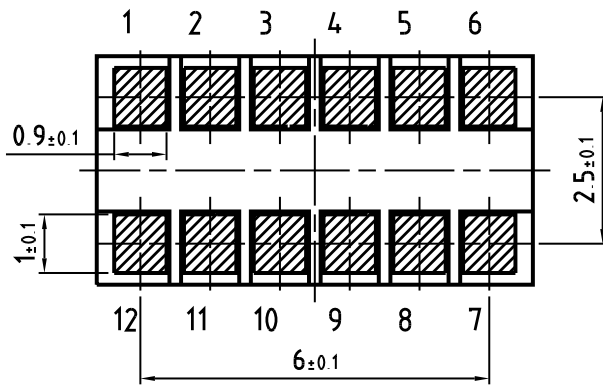
$$S_{\text{rel}} = f(\varphi), \lambda=530\text{nm}$$

**Radiation characteristics of emitters** <sup>1)</sup>

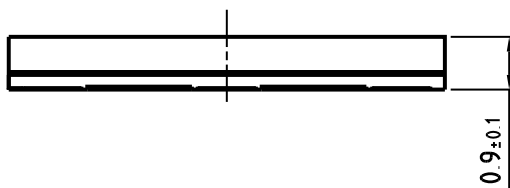
$$I_{\text{rel}} = f(\varphi)$$



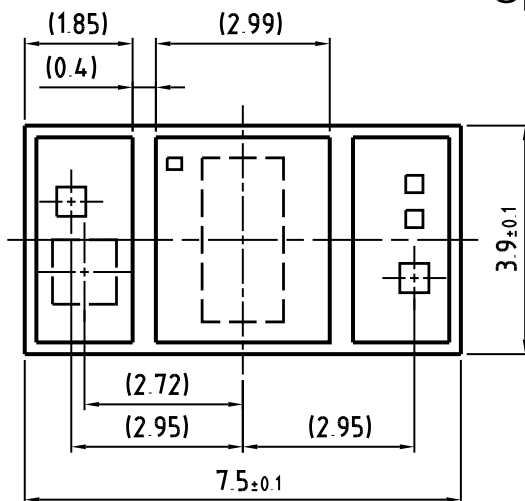
## Package Outline



BOTTOM VIEW



SIDE VIEW



TOP VIEW

Pin	Name	Function
1	BPC	Broadband photodiode cathode
2	BPA	Broadband photodiode anode
3	IPC	IR-Cut photodiode cathode
4	IA	Infrared LED anode
5	G1A	Green LED 1 anode
6	G1C	Green LED 1 cathode
7	RA	Red LED anode
8	RC	Red LED cathode
9	IC	Infrared LED cathode
10	IPA	IR-Cut photodiode anode
11	G2A	Green LED 2 anode
12	G2C	Green LED 2 cathode

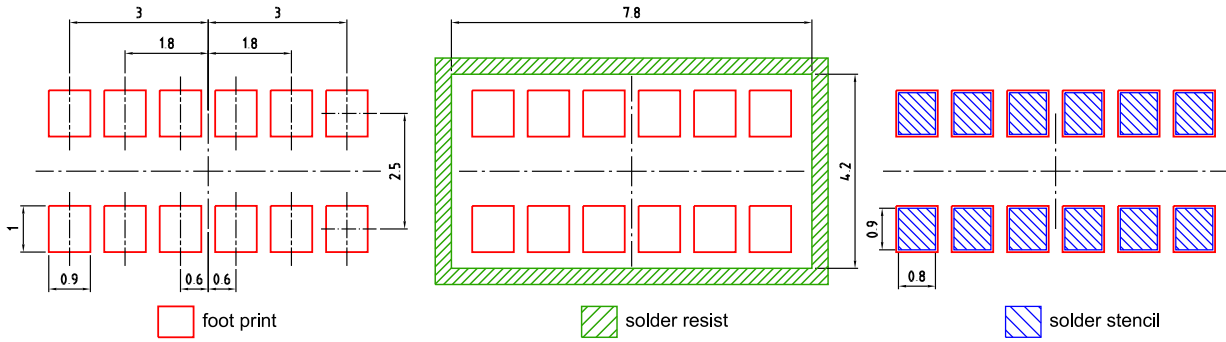
Dimensions in mm

**Package:**  
chip on board

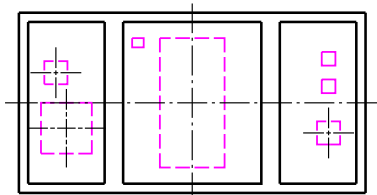
**Approximate Weight:**  
44 mg

C63062-A4325-A1-01

**Recommended solder pad design**



Component Location on Pad

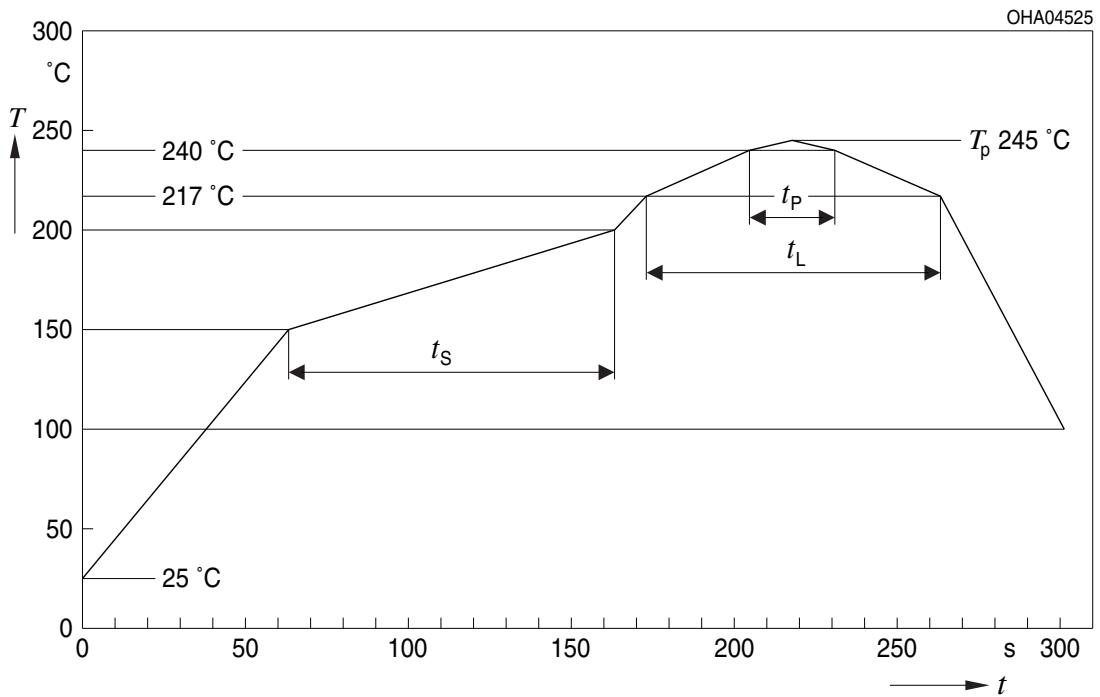


E062.3010.217-01

Dimensions in mm.

**Reflow Soldering Profile**

Product complies to MSL Level 4 acc. to JEDEC J-STD-020D.01



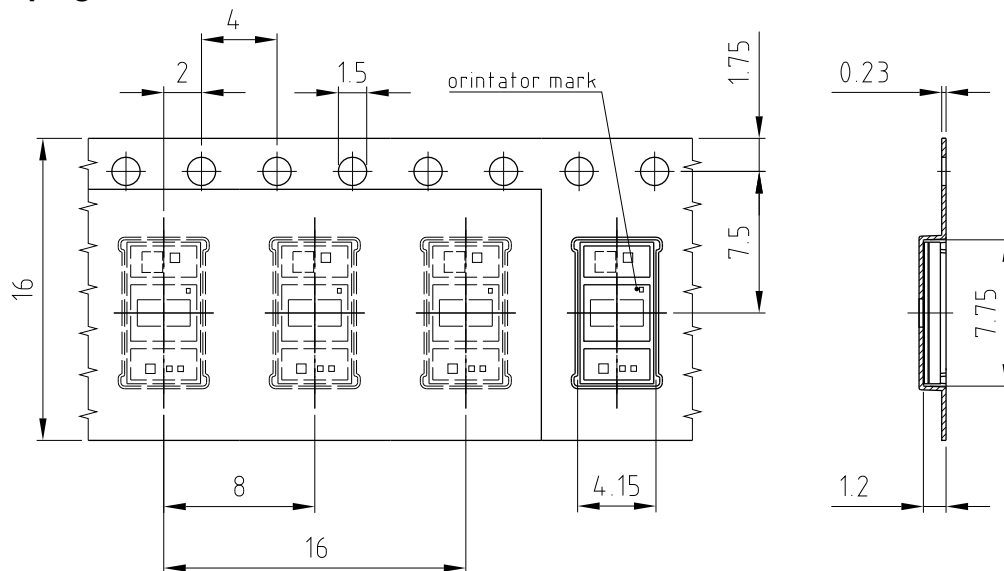
OHA04612

Profile Feature Profil-Charakteristik	Symbol Symbol	Pb-Free (SnAgCu) Assembly			Unit Einheit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_S$ $T_{Smin}$ to $T_{Smax}$	$t_S$	60	100	120	s
Ramp-up rate to peak*) $T_{Smax}$ to $T_P$			2	3	K/s
Liquidus temperature	$T_L$	217			°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_P$		245	260	°C
Time within 5 °C of the specified peak temperature $T_P - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_P$ to 100 °C			3	6	K/s
Time 25 °C to $T_P$				480	s

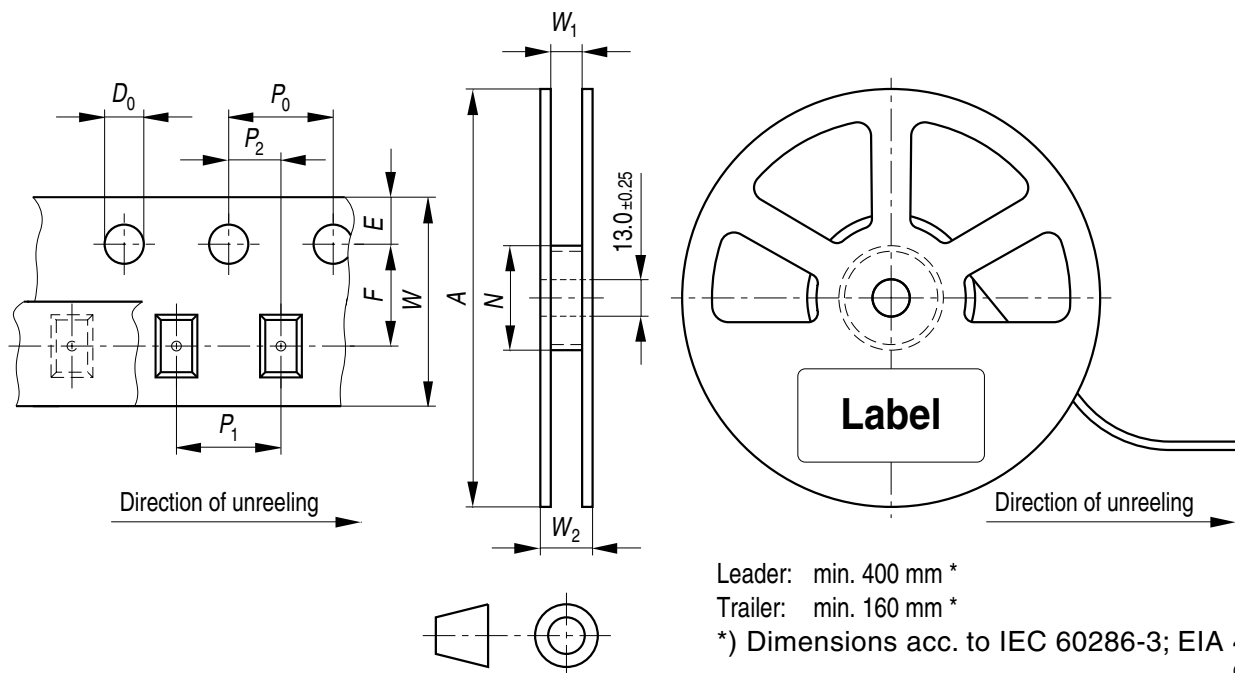
All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

## Method of Taping



Dimensions in mm.

**Tape and Reel**16 mm tape with 1500 pcs. on  $\varnothing$  180 mm reel

Dimensions in mm

**Tape Dimensions [mm]**

W	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	D <sub>0</sub>	E	F
16 +0.3 / -0.1	4 ±0.1	8 ±0.1	2 ±0.05	1.5 ±0.1	1.75 ±0.1	7.5 ±0.05

**Reel Dimensions [mm]**

A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2max</sub>
180	16	60	16.4 +2	22.4

Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors** LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

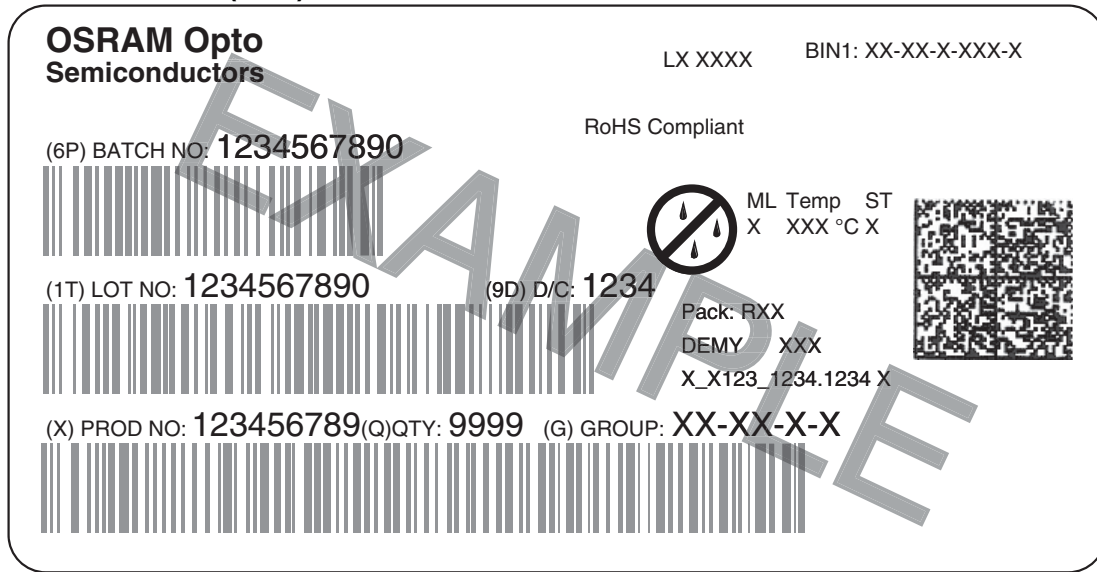
(6P) BATCH NO: 1234567890

(1T) LOT NO: 1234567890 (9D) D/C: 1234

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

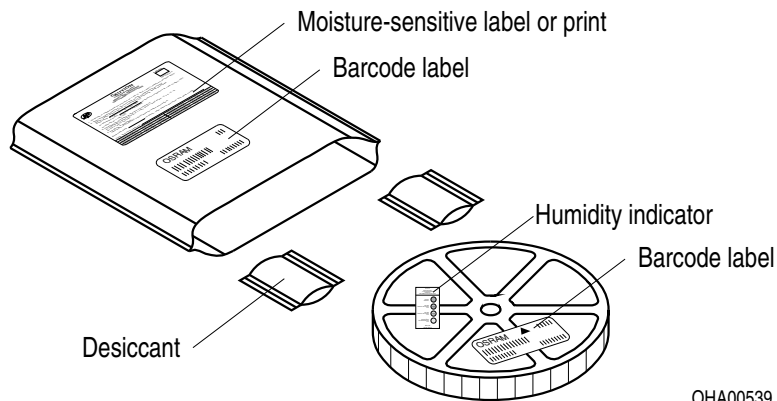
ML Temp ST  
X XXX °C X

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X



OHA04563

Dry Packing Process and Materials

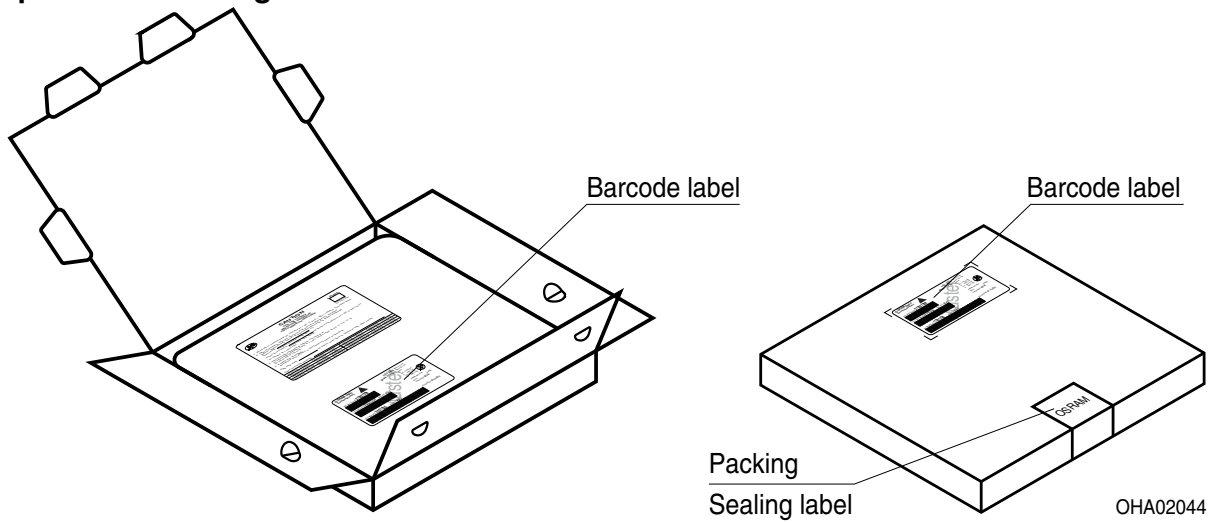


OHA00539

Note:

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card. Regarding dry pack you will find further information in the internet. Here you will also find the normative references like JEDEC.

### Transportation Packing and Materials



### Dimensions of transportation box in mm

Width	Length	Height
195 ± 5	195 ± 5	42 ± 5



## Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics.

Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization. If printed or downloaded, please find the latest version in the Internet.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Components used in life-support devices or systems must be expressly authorized for such purpose!

Critical components\* may only be used in life-support devices\*\* or systems with the express written approval of OSRAM OS.

\*) A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or the effectiveness of that device or system.

\*\*) Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health and the life of the user may be endangered.

## Glossary

1) **Typical Values:** Due to the special conditions of the manufacturing processes of LED and photodiodes, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

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